

STM32WB09xE device errata

Applicability

This document applies to the part numbers of STM32WB09xE devices and the device variants as stated in this page.

It gives a summary and a description of the device errata, with respect to the device datasheet and reference manual RM0505.

Deviation of the real device behavior from the intended device behavior is considered to be a device limitation. Deviation of the description in the reference manual or the datasheet from the intended device behavior is considered to be a documentation erratum. The term “*errata*” applies both to limitations and documentation errata.

Table 1. Device summary

Reference	Part numbers
STM32WB09xE	STM32WB09KE, STM32WB09TE

Table 2. Device variants

Reference	Silicon revision codes	
	Device marking ⁽¹⁾	DIE_ID ⁽²⁾
STM32WB09KEVx	Z	0x0110
STM32WB09TEFx		

1. Refer to the device datasheet for how to identify this code on different types of package.

2. REVISION[3:0] bitfield of the DIE_ID register.

1 Summary of device errata

The following table gives a quick reference to the STM32WB09xE device limitations and their status:

A = limitation present, workaround available

N = limitation present, no workaround available

P = limitation present, partial workaround available

“-” = limitation absent

Applicability of a workaround may depend on specific conditions of target application. Adoption of a workaround may cause restrictions to target application. Workaround for a limitation is deemed partial if it only reduces the rate of occurrence and/or consequences of the limitation, or if it is fully effective for only a subset of instances on the device or in only a subset of operating modes, of the function concerned.

Table 3. Summary of device limitations

Function	Section	Limitation	Status
			Rev. Z
System	2.2.1	SMPS with BOM1 does not work properly at 4 MHz	A
Radio system	2.3.1	Possible RX lock when receiving connectionless AoA/AoD packet	P
GPIO	2.4.1	Activity on some GPIOs may affect the RF performance	P
RTC	2.5.1	RTC alarm is not able internally to wake up the device from Deepstop mode	A
	2.5.2	RTC interrupt not triggered in Run mode	P

2 Description of device errata

The following sections describe the errata of the applicable devices with Arm® core and provide workarounds if available. They are grouped by device functions.

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arm

2.1 Core

Reference manual and errata notice for the Arm® Cortex®-M0+ core revision r0p1 is available from <http://infocenter.arm.com>.

2.2 System

2.2.1 SMPS with BOM1 does not work properly at 4 MHz

Description

When using the bill of material BOM1 (inductor of 1.5 µH and capacitor of 2.2 µF), and when the frequency switching (Fs) is set at 4 MHz, the SMPS cannot deliver the right output voltage.

Workaround

Set the frequency switching to 8 MHz if the BOM1 is required for low-profile-height components.
 If no low-profile-height components are required, use the standard bill of material BOM3 (inductor of 10 µH and capacitor of 4.7 µF).

2.3 Radio system

2.3.1 Possible RX lock when receiving connectionless AoA/AoD packet

Description

In some specific conditions, when it is receiving an advertising packet with CTE extension, the digital radio can be stuck in the RX state. Typically, an extended advertising packet including a CTE extension includes at least 3 bytes of payload. If the packet is malformed or corrupted over the air, and if it is understood by the digital radio with a payload length of either 1 or 2 bytes, it locks the deframing process of the digital radio, which stays in RX state.

The digital radio stays in the RX state and never reports any interrupt to the software about the completion of the reception. This occurs using either LE_1M or LE_2M phy.

Workaround

When the software is preparing to receive an extended advertising packet with CTE (setting TxRxPack.CTEAndSamplingEnable = 1 and TxRxPack.Advertise = 1), it must assume that the radio can be locked, and never terminate the operation autonomously.

It may set a parallel timer watchdog with a duration of the maximum expected payload and CTE information. If the watchdog timer expires without receiving any interruption, it must abort the current receive operation.

2.4 GPIO

2.4.1 Activity on some GPIOs may affect the RF performance

Description

RF performance can be degraded in the presence of one of the following conditions:

- VFQFPN32 package only: toggling activity on PB14 and PB15 during RF communication
- VFQFPN32 and WLCSP49 packages: GPIO tracks are routed close to OSCIN/OSCOUT pins and toggling activity on those GPIOs during RF communications.

The user might experience a high packet error rate during RF communications.

Workaround

- VFQFPN32 package only: avoid toggling PB14 and PB15 (input or output) during RF communications.
- VFQFPN32 and WLCSP49 packages: avoid routing GPIO tracks close to OSCIN/OSCOUT tracks, if they are toggling during RF communications.

2.5 RTC

2.5.1 RTC alarm is not able internally to wake up the device from Deepstop mode

Description

The RTC is able to run in Deepstop mode but it cannot generate an internal RTC alarm wake-up event. An RTC alarm cannot be used as an internal wake-up source when the device is in Deepstop mode.

Workaround

In software, output an RTC alarm on PA8 and use this as the wake-up pin from Deepstop mode.

2.5.2 RTC interrupt not triggered in Run mode

Description

The RTC interrupts might get lost in Run mode when the selected RTC clock source is LSI or LSE. The problem does not occur when the RTC clock source is CLK_16MHz/512.

RTC interrupts cannot be reliably used for real-time control functions, since some occurrences of RTC interrupts may be missed.

Note: Wakeup from Deepstop mode is not affected and RTC interrupt is always reliable in Deepstop mode.

Workaround

While in Run mode, do not use RTC interrupts, but instead use polling on the RTC_ISR register. Another possible option is to output the RTC alarm or wake-up on PA8 or PA9, and use one of these pins as an I/O interrupt pin.

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Revision history

Table 4. Document revision history

Date	Version	Changes
22-Jan-2024	1	Initial release.
5-Nov-2024	2	Added SMPS with BOM1 does not work properly at 4 MHz

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